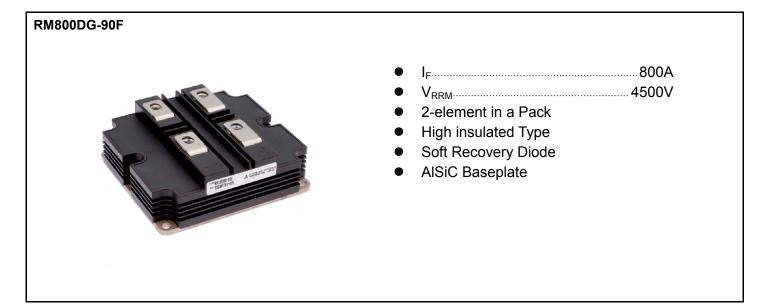


< HIGH VOLTAGE DIODE MODULES >

## RM800DG-90F

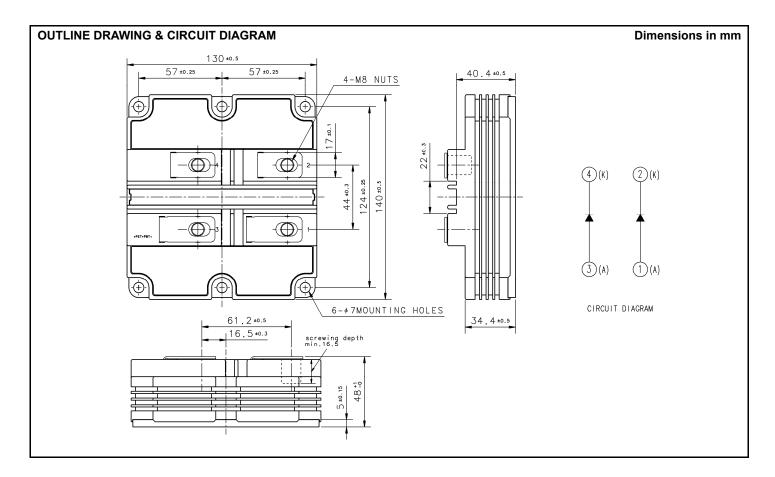
HIGH POWER SWITCHING USE INSULATED TYPE

High Voltage Diode Modules



#### APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



#### **MAXIMUM RATINGS**

Symbol	Item	Conditions	Ratings	Unit	
V <sub>RRM</sub>	Repetitive peak reverse veltage	T <sub>j</sub> = −40…+125°C	4500	v	
	Repetitive peak reverse voltage	$T_j = -50^{\circ}C$	4400	v	
I <sub>F</sub>	Forward current	DC, $T_c = 65^{\circ}C$	800	А	
I <sub>FSM</sub>	Surge forward current	$T_{i \text{ start}} = 125^{\circ}C, t_{p} = 10 \text{ ms}, \text{ Half-sine wave}, V_{R} = 0 \text{ V}$	6.5	kA	
$I_t^2$	Surge current load integral	$I_{j\_start} = 123 \text{ C}, t_p = 10 \text{ HIS}, \text{ Fidil-Sille wave}, V_R = 0 \text{ V}$	211	kA <sup>2</sup> s	
P <sub>tot</sub>	Maximum power dissipation	$T_c = 25^{\circ}C$	4160	W	
V <sub>iso</sub>	Isolation voltage	RMS, sinusoidal, f = 60 Hz, t = 1 min.	10200	V	
Ve	Partial discharge extinction voltage	RMS, sinusoidal, f = 60 Hz, $Q_{PD} \le 10 \text{ pC}$	3500	V	
Tj	Junction temperature		-50 ~ +150	°C	
T <sub>jop</sub>	Operating junction temperature		-50 ~ +125	°C	
T <sub>stg</sub>	Storage temperature		-55 ~ +125	°C	

#### **ELECTRICAL CHARACTERISTICS**

Symbol	Item	Conditions		Limits			Unit
Symbol	item			Min	Тур	Max	Unit
	Repetitive reverse current	$V_{RM} = V_{RRM}$	T <sub>j</sub> = 25°C			1.0	mA
I <sub>RRM</sub>	Repetitive reverse current	VRM − VRRM	T <sub>j</sub> = 125°C		3.0	_	ША
V <sub>EM</sub>	Forward voltage	I <sub>E</sub> = 800 A	T <sub>j</sub> = 25°C	_	2.55		v
VFM	Forward voltage	1 <sub>F</sub> = 800 A	T <sub>j</sub> = 125°C	_	2.85	3.45	v
	Reverse recovery time		T <sub>j</sub> = 25°C	_	0.70	_	
t <sub>rr</sub>		V <sub>CC</sub> = 2800 V	T <sub>j</sub> = 125°C		0.90	_	μs
1	Boverse recovery current	I <sub>F</sub> = 800 A	T <sub>j</sub> = 25°C		700	_	А
Irr	Reverse recovery current		T <sub>j</sub> = 125°C	_	760	_	A
0		-d <sub>i</sub> /d <sub>t</sub> = 2600 A/μs @ T <sub>j</sub> = 25°C -d <sub>i</sub> /d <sub>t</sub> = 2400 A/μs @ T <sub>j</sub> = 125°C	T <sub>j</sub> = 25°C	_	660		
Qrr	Revers0He recovery charge		T <sub>j</sub> = 125°C		1040	_	μC
-	Reverse recovery energy (Note 1)	L <sub>s</sub> = 150 nH	T <sub>j</sub> = 25°C	_	0.96	_	
E <sub>rec(10%)</sub>			T <sub>i</sub> = 125°C		1.50		J
Е	Boyeres resources energy	Inductive load	T <sub>j</sub> = 25°C		1.10	_	
E <sub>rec</sub>	Reverse recovery energy		T <sub>j</sub> = 125°C		1.70	_	J

#### THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
Symbol			Min	Тур	Max	Unit
R <sub>th(j-c)</sub>	Thermal resistance	Junction to Case (per 1/2 module)		_	30.0	K/kW
R <sub>th(c-s)</sub>	Contact thermal resistance	Case to heat sink, $\lambda_{grease} = 1 \text{ W/m}^{k}$ D <sub>(c-s)</sub> = 100 µm (per 1/2 module)	_	24.0	_	K/kW

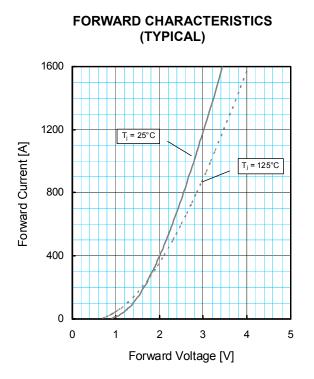
#### **MECHANICAL CHARACTERISTICS**

Symbol	Item	Conditions	Limits			Unit
			Min	Тур	Max	Unit
Mt	Manuatian termina	M8 : Main terminals screw	7.0	—	22.0	N∙m
Ms	Mounting torque	M6 : Mounting screw	3.0	_	6.0	N∙m
m	Mass		—	1.0		kg
CTI	Comparative tracking index		600	—	—	—
d <sub>a</sub>	Clearance		26.0	_	_	mm
ds	Creepage distance		56.0	_	_	mm
L <sub>P AK</sub>	Parasitic stray inductance		_	22.0		nH
R <sub>AA'+KK'</sub>	Internal lead resistance	$T_c = 25^{\circ}C$	_	0.14	_	mΩ

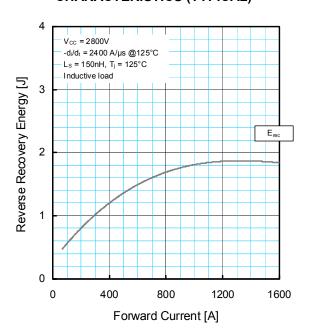
Note 1. Note 2.

 $\mathsf{E}_{\mathsf{rec}(10\%)}$  are the integral of 0.1V<sub>R</sub> x 0.1I<sub>F</sub> x dt. Definition of all items is according to IEC 60747, unless otherwise specified.

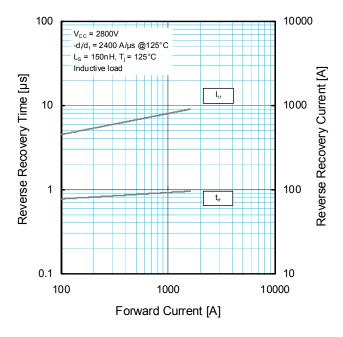
#### PERFORMANCE CURVES



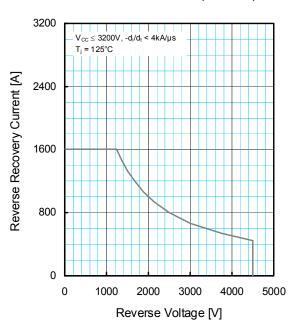
#### **REVERSE RECOVERY ENERGY** CHARACTERISTICS (TYPICAL)



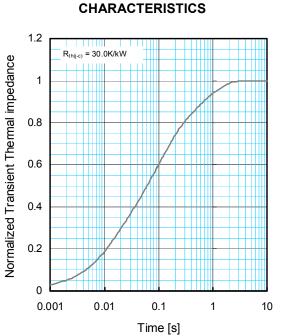
REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



#### REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



#### PERFORMANCE CURVES



**TRANSIENT THERMAL IMPEDANCE** 

# $Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - exp^{\left(-\frac{t}{\tau_{i}}\right)} \right\}$

	1	2	3	4
R <sub>i</sub> [K/kW]	0.0055	0.2360	0.4680	0.2905
t <sub>i</sub> [sec]	0.0001	0.0131	0.0878	0.6247

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